EAST Search History

Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	(0123129 03267095). pn.	JPO	OR	OFF	2009/04/17 05:48
L2	1	("01231329").pn.	JPO	OR	OFF	2009/04/17 05:50
L3	0	1 and 2	JPO	OR	OFF	2009/04/17 05:52
L4	2	1 2	JPO	OR	OFF	2009/04/17 05:52
L5	0	("20010025431" "20020166256" "20030172542" "20040045184" "20040123484" "20040216325" "20050160619" "20050183283" "20060005420" "20070169373" "20070220775" "20080052947" "20080127508" "4258731" "4434563" "4531307" "4724621" "5369891" "5526578" "5582721" "5826128" "5582721" "5826128" "6398875" "6473993" "6562146" "6596093" "6602351" "6613157" "6649883" "6796054" "6808567" "6966949" "6986214" "7024798" "7225819" "7347006").PN.	JPO	OR	OFF	2009/04/17

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		"6596093" "6602351" "6613157" "6641678" "6649883" "6796054" "6808567" "6966949" "6986214" "7024798" "7225819" "7347006").PN. not ("4693211" "4817299").PN. not ("5885353" "6099643").PN.			<i>анишинанинанинанинанинанинанинанинанинан</i>	
L8	727250	(wafer semiconductor substrate) and temperature and (control\$3 regulat\$3 adjust\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:17
L9	370645	(wafer semiconductor substrate) and temperature same (control\$3 regulat\$3 adjust\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:17
L10	236297	(wafer semiconductor substrate) and temperature with (control\$3 regulat\$3 adjust\$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:17
L11	1123	(wafer semiconductor substrate) and temperature and (control\$3 regulat\$3 adjust\$3) and "34"/\$. ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:17
L12	84	(wafer semiconductor substrate) and temperature and (control\$3 regulat\$3 adjust\$3) and "34"/78-80.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:18
L13	468	(wafer semiconductor substrate) and temperature and (control\$3 regulat\$3 adjust\$3) and "34"/380-497.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:18
L14	519	(12 13) and 8	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:19

L15	401	(12 13) and 9	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:19
L16	329	(12 13) and 10	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:19
L17	519	(12 13) and 11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO	OR	OFF	2009/04/17 08:19

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